Results of Checking the Status of Use of PFOS

V1.0 2007/9/1

【Information on Surveyed Company (Supplier)】

Company code:	(Common/local)
Company name/site or plant name:	Nagase ChemteX Corporation Harima Plant
Location:	236, Tatsunocho-nakai, Tatsuno, Hyogo, 679-4124, Japan
Department/division name:	Regulatory Affairs Division
Completed by:	Toshihiro Ishihara
E-mail:	toshihiro.ishihara@ncx.nagase.co.jp
Phone:	+81-791-63-2915
Fax:	+81-791-63-9088
Date of completion:	2007/10/31

《Comments Field》＊Please write your comments, requests, or messages here (optional).

The following products are using PFOS below a threshold value.

	Write the part number you supply to Ricoh Group.	Write the name of parts or products you supply to Ricoh Group.	Specify the location where PFOS is used and its application.	Specify whether or not an alternative technique is available.	Outline the alternative technique, for example, an alternative material.	Write issues related to replacement, if any.	Specify the timing of switchover to replacement.	Write suggestions or notes (optional).
No.	**Ricoh's part number**	**Product name**	**Location where PFOS is used/purpose**	**Availability of alternative technique**	**Outline of alternative technique**	**Issues related to replacement**	**Timing of switchover**	**Remarks**
Sample 1	AXXX-XXXX	PC board	Penetrant and wetting agents	None	—	—	To be determined	
Sample 2	BXXX-XXXX	Sliding bearing	Slide materials	Available	Switchover to alternative material	Performance degradation	January 1,2008	
1		EPOXY RESIN T693/R1004	raw material/surface tension depressant	Available	Switchover to alternative material	-	To be determined	PFOS content: ca. 100ppm
2		EPOXY RESIN T693/R1007LV6	raw material/surface tension depressant	Available	Switchover to alternative material	-	To be determined	PFOS content: ca. 50ppm
3		EPOXY RESIN T693/R1001	nonuse	-	-	-	-	-
4								
5								
6								
7								
8								
9								
10								
11								
12								